



# DATA SHEET

## MLCC Chip Capacitor Size 1812

**Serie: I11009**

Mat. Code	<b>X7R</b>	Material: <b>X7R= X7R Material</b>
Voltage Code	<b>6V3</b>	Voltage: <b>6V3= 6,3 Volt</b>
Range Code	<b>103</b>	Range: <b>103= 10000pf</b>

**MLCC Chip Capacitor Size  
1812**

Serie No.: **I11009**

Customer:

DRW:	Jason	CHKD	Wilson	MATL:	Wilson	TOLERANCE	Mason	DATE	25.10.2010
APPD:	Schumi			FINISH	Jamy		Sheet No.		1 from 14







# EDCON-COMPONENTS



## Reliability Test

Item	Technical specification				Test Methods and Remarks			
Capacitance	Class I	Should be within the specified tolerance		Capacitance	Measuring Frequency		Measuring Voltage	
				≤1000pf	1MHz +/- 10%		1,0 Tol. 0,2Vrms	
				≥1000pf	1KHz +/- 10%			
DF, tan Dissipation Favctor	Class II	Should be within the specified tolerance		C≤10μF	Test Frequency 1KHZ +/-10%			
				Test Voltage 1,0 +/- 0,2Vrms				
				X7R, Y5V				
				C>10μF	Test Frequency 1KHZ +/-10%			
				Test Voltage 1,0 +/- 0,2Vrms				
				Z5U				
	Test Frequency 1KHZ +/-10%							
	Test Voltage 1,0 +/- 0,2Vrms							
	Class I	DF≤ 0,15%		Capacitance	Measuring Frequency		Measuring Voltage	
				≤1000pf	1MHz +/- 10%		1,0 Tol. 0,2Vrms	
≥1000pf				1KHz +/- 10%				
Class II	X7R	>50V	25V	16V	10V	6,3V	C= 10μF	
		≤ 2,5%	≤ 3,5%	≤ 3,5%	≤ 5%	≤ 5%	Test Frequency 1KHZ +/-10%	
						≤ 10%	Test Voltage 1,0 +/- 0,2Vrms	
						( C≥ 3,3μF)		

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## Reliability Test

DF, tan Dissipation Factor	Class II	Y5V / Z5U	≥25V	16V	10V	6,3V	C= 10μF X7R; Y5V		
			≤ 7,0%	≤12,5%	≤12,5%	≤12,5%	Test Frequency 120Hz +/-20Hz		
			( C < 1,0μF)				Test Voltage 0,5 +/- 0,1Vrms		
			≤ 9,0%				Test Frequency 0,1KHz		
( C ≥ 1,0μF)	Test Voltage 0,5 +/- 0,05Vrms								
(IR) Insulation Resistance	Class I	C ≤ 10nf, Ri ≥ 50000MΩ C > 10nf, Ri ≥ 500S					Measuring Voltage: Rated Voltage Duration: 60Sec. +/- 5s		
									Class II
	Y5V / Z5U	C ≤ 25nf, Ri ≥ 4000MΩ C > 25nf, Ri ≥ 100S							
		Item							Technical Specification
(DWV) Dielectric Withstanding Voltage	No Breakdown or damage				Measuring Voltage: Class I: 300% Rated Voltage Class II: 250% Rated Voltage Duration : 5 +/-1sec Charge / Discharge Current : 50mA max. This method excludes high voltage MLCC				
Solderability	At least 95% of the terminal electrode is covered by new solder. Visual Appearance: No visible damage:				Solder Temperature: 235°C +/- 5°C Duration : 2 +/-0,5sec				

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## Reliability Test

Resistance to Soldering Heat	Item	NPO to SL	X7R	Y5V	Z5U	Preheating conditions: 100 to 200°C +/- 10°C 2mon. Solder Temperature: 265°C +/- 5°C Duration 5sec. +/- 1sec. Clean the capacitor with solvent and examine it with a 10x(min) microscope. Recovery time : 24hrs +/-2hrs Recovery conditions: Room temperature
	C/C	≤ 0,5%	. -5 ~ +10%	. -10 ~ +20%		
	DF	Same to initial Value				
	IR	Same to initial Value				
	Apperance: No visible damage. At least 95% of the terminal electrode is covered by new solder.					
Resistance to Flexure of Substrate ( Bending Strength)	Apperance: No visible damage.					<p>Test Board: Al2O3 or PCB                  Wrap: 1mm                  Speed 0,5mm/sec.                  Unit: mm                  The measurement should be mader with the board in bending position.</p>
	C/C	≤ +/- 10%				

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## Reliability Test

Item	Technical specification		Test Methods and Remarks															
Termination Adhesion	No visible damage		Applied Force: 5N Duration: 10sec +/- 1sec															
Temperature Cycle	Class I : $\leq \pm 1\%$ or 1pf whichever is larger. Class II: B: $\leq \pm 10\%$ E,F: $\leq \pm 20\%$		Preheating conditions: up-category temperature 1hrs Recovery time: 24hrs +/-1hrs Initial Measurement Cycling Tiems 5times, 1cycle, 4steps															
			<table border="1"> <thead> <tr> <th>Step</th> <th>Temperature (°C)</th> <th>Time (min)</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>Low-category temp. (NPO / X7R / Y5V / Z5U)</td> <td>30</td> </tr> <tr> <td>2</td> <td>Normal Temp. (+20)</td> <td>2~3</td> </tr> <tr> <td>3</td> <td>Up-category temp. (NPO / X7R / Y5V / Z5U)</td> <td>30</td> </tr> <tr> <td>4</td> <td>Normal Temp. (+20)</td> <td>2~3</td> </tr> </tbody> </table>	Step	Temperature (°C)	Time (min)	1	Low-category temp. (NPO / X7R / Y5V / Z5U)	30	2	Normal Temp. (+20)	2~3	3	Up-category temp. (NPO / X7R / Y5V / Z5U)	30	4	Normal Temp. (+20)	2~3
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			2	Normal Temp. (+20)	2~3													
3	Up-category temp. (NPO / X7R / Y5V / Z5U)	30																
4	Normal Temp. (+20)	2~3																
Recovery time after test 24hrs +/- 2hrs																		
Moisture Resistance	C/C	Class I $\leq \pm 2\%$ or 1pf whichever is larger	Temperature: 40°C +/-2°C Humidity: 90~95% RH Voltage: Rated Voltage Duration: 500hrs Charge/Discharge Current: 50mA max. Recovery Time; 24hrs (Class I) or 48hrs (Class II)															
		Class II B: $\leq \pm 10\%$ Class II E,F: $\leq \pm 30\%$																
	DF	Not more than twice of initial value																
	IR	Class I: $R_i \geq 2500M\Omega$ $R_i/C_r \geq 25sec$ whichever is smaller																
		Class II: $R_i \geq 1000M\Omega$ $R_i/C_r \geq 25sec$ whichever is smaller																
Visual Apperance: No visible damage																		

Note: Pretreatment (only for class 2 capacitor)

Pretradmment (only for class 2 capacitor) is a method to treat the capacitor before measurement. First place the capacitor in the up-category temperastature or other specified higher temperature environment for 1 hour. Then recovery the capacitor at standard pressure conditions for 24hours +/-1hrs..

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Customer:



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## Package Conditions



Dimension of paper taping for size 0603, 0805, 1206



Dimension of paper taping for size 0402



Paper Size Size Code	A	B	C	D	E	F	G	H	J	T
0603	1,10 ±0,20	1,90 ±0,20	8,00 ±0,20	3,50 ±0,05	1,75 ±0,10	4,00 ±0,10	2,00 ±0,10	4,00 ±0,10	1,50 ±0,10	1,10 below
0805	1,45 ±0,20	2,30 ±0,20	8,00 ±0,20	3,50 ±0,05	1,75 ±0,10	4,00 ±0,10	2,00 ±0,10	4,00 ±0,10	1,50 ±0,10	1,10 below
1206	1,80 ±0,20	3,40 ±0,20	8,00 ±0,20	3,50 ±0,05	1,75 ±0,10	4,00 ±0,10	2,00 ±0,10	4,00 ±0,10	1,50 ±0,10	1,10 below

Code	W1	L1	D	C	B	P1	P2	P0	d	t
0402	0,65	1,15	8,0	3,5	1,75	2	2	4	1,5	0,8
	±0,20	±0,20	±0,20	±0,05	±0,10	±0,05	±0,05	±0,05	±0,10	below

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## Package Conditions

Dimension of paper taping for size 0805 ~ 1812



Paper Size Size Code	A	B	C	D	E	F	G	H	J	T
0805	1,55 ±0,20	2,35 ±0,20	8,00 ±0,20	3,50 ±0,05	1,75 ±0,10	4,00 ±0,10	2,00 ±0,10	4,00 ±0,10	1,50 ±0,10	1,50 below
1206	1,95 ±0,20	3,60 ±0,20	8,00 ±0,20	3,50 ±0,05	1,75 ±0,10	4,00 ±0,10	2,00 ±0,10	4,00 ±0,10	1,50 ±0,10	1,50 below
1210	2,70 ±0,10	3,42 ±0,10	8,00 ±0,10	3,50 ±0,05	1,75 ±0,10	4,00 ±0,10	2,00 ±0,10	4,00 ±0,10	1,55 ±0,10	1,55 ±0,10
1808	2,20 ±0,10	4,95 ±0,10	12,00 ±0,10	5,50 ±0,05	1,75 ±0,10	4,00 ±0,10	2,00 ±0,10	4,00 ±0,10	1,50 ±0,10	1,80 ±0,10
1812	3,66 ±0,10	4,95 ±0,10	12,00 ±0,10	5,50 ±0,05	1,75 ±0,10	8,00 ±0,10	2,00 ±0,10	4,00 ±0,10	1,55 ±0,10	1,85 ±0,10



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## Package Conditions

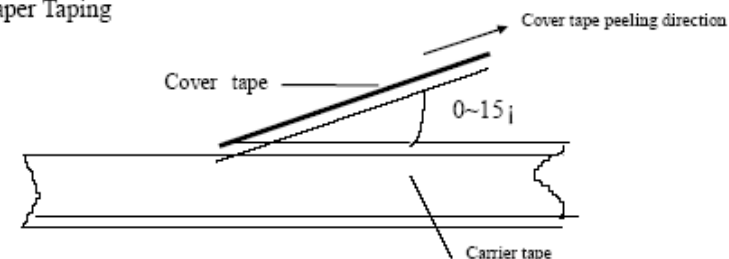


**Dimension of Reel (mm)**

	A	B	C	D	E	F	G
7' Reel	Ø178 ± 2,0	3,0	Ø13 ± 0,5	Ø21 ± 0,8	Ø50 or more	Ø10 ± 1,5	12 max.
13' Reel	Ø330± 2,0	3,0	Ø13 ± 0,5	Ø21 ± 0,8	Ø50 or more	Ø10 ± 1,5	12 max.

## Taping Specification

### Paper Taping



### Embossed Taping



Standard: 0,1N < peeling strength < 0,7N

No paper dirty remains on the scotch when peeling, and sticks to top an bottem tape

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## Packing Quantity

Size	Packing Style Quantity			
	PT	ET	BC	BP
0402	10000	-----	20000	5000
0603	5000	-----	15000	5000
0805	5000	2500	10000	5000
1206	5000	2500	5000	5000
1210	-----	2000	-----	2000
1808	-----	2000	-----	2000
1812	-----	2000	-----	2000
2225	-----	-----	-----	500
3035	-----	-----	-----	-----

Note: We can choose packing style and quantity can be according to the customer requirement

## Soldering Informations

### Storage Methods

The guaranteed period for solderability is 6 month ( Under deliver package conditions).

Storage conditions:

Temperature: 5~40°C

Relative Humidity: 20~70%

### Precautions for use

The Multilayer Ceramic Capacitor (MLCC) may fail in a short circuit modern in an open circuit mode when subjected to severe conditions of electrical and / or mechanical stress beyond the specified rating and specified conditions in the specification, which will result in burn out, flaming or glowing in the worst case.

Following precautions for safety and Application Notes shall be taken in your major consideration. If you have a question about the precautions für handling, please consult our engineering department of our factory.

### Manual Soldering

Manual Soldering can pose a great risk of ceramic thermal cracks in capacitios. The hot soldering iron tip comes into direct contact with the end terminations, and operator careless may cause the tip of the soldering iron to come into direct contact with the ceramic body of the capacitor. Therefore the soldering iron must be handled carefully, and oay much attention to the selection of the soldering iron tip and temperature contact of the tip.

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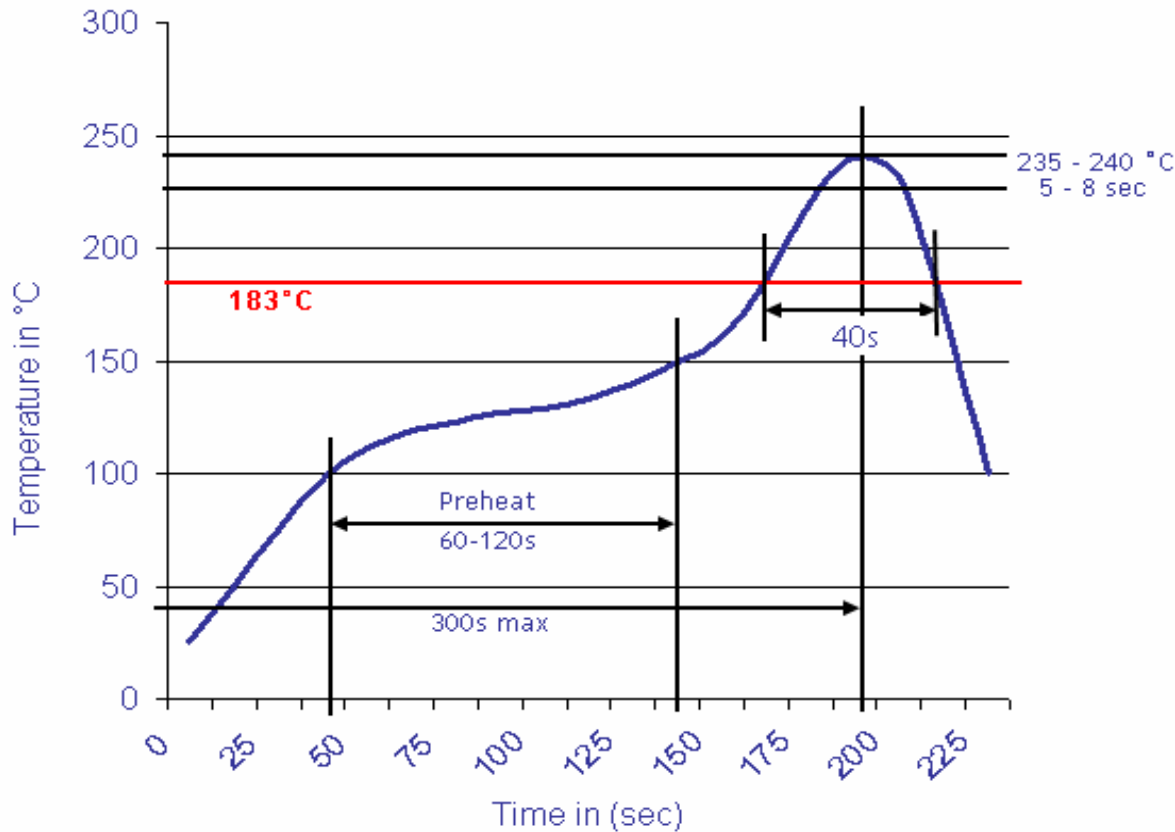
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Soldering Profile Curve

Classification Reflow Profile (JEDEC J-STD-020C)



Too much solder  
Cracks tend occur due to large stress



Not enough solder  
Weak holding force may cause bad connection between the capacitor and PCB



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## Ordering Information

Serie	Range	Material	Voltage	Capacitance Tolerance	Termination Material	No Function	No Function	ROHS	Packing	
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<b>I11009</b>	<b>103</b>	<b>X7R</b>	<b>6V3</b>	<b>K</b>	<b>N</b>	<b>N</b>	<b>N</b>	<b>R</b>	<b>TR</b>	
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MLCC Chip Capacitor Size 1812	<b>103=</b> 10000pf	<b>X7R=</b> X7R Material	<b>6V3=</b> 6,3 Volt	<b>K=</b> Tol. 10%	<b>S=</b> Silver Termination <b>C=</b> Copper Termination <b>N=</b> Nickel Termination	<b>N=</b> No Function	<b>N=</b> No Function	<b>R=</b> Rohs Conform <b>N=</b> NON Rohs Conform	<b>TR=</b> Tape / Reel <b>BU=</b> Bulk Ware
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